

LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
IR	-		U	ECR-05-012760	1-OCT-05	-	JB
			V	ECR-10-020218	28DEC2010	PS	RRP
			W	ECO-13-015831	9OCT2013	AD	SH
			Y	ECO-17-017971	08DEC2017	AD	SH

D

D

C

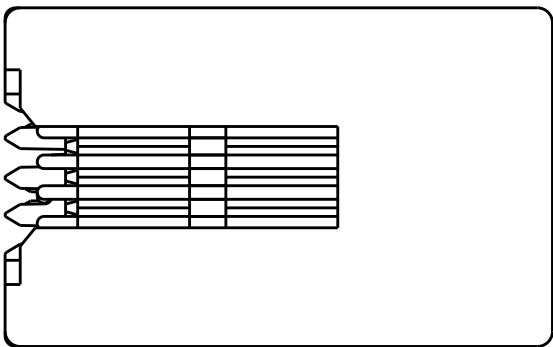
C

B

B

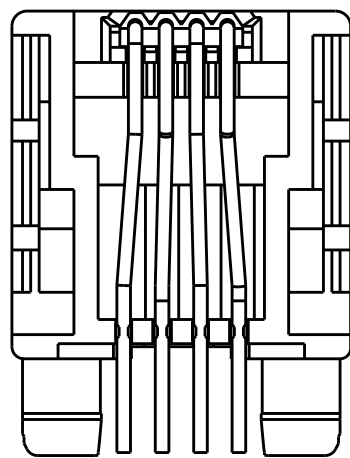
A

A



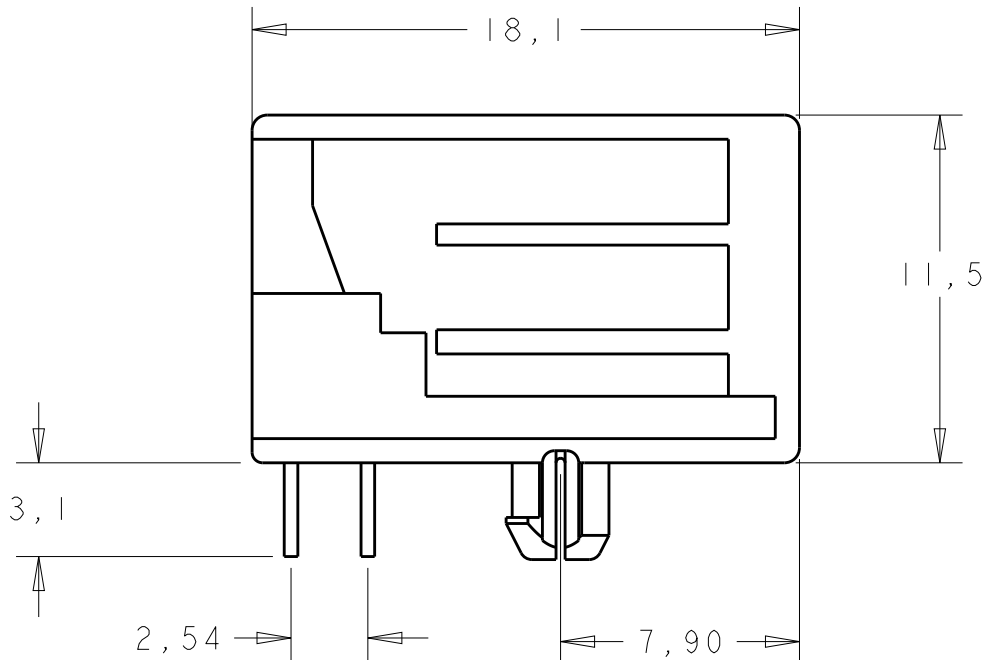
NOTES:

- 1 TOLERANCE UNLESS OTHERWISE SPECIFIED: 0,15.
- 2 BULK PACKAGING: TRUE POSITIONING OF THE SOLDER TINES IS NOT GUARANTEED.
- 3 SUPERSEDED BY 1-215876-3
- 4 SUPERSEDED BY 215875-1
- 5 OBSOLETE 3-215875-3



1,27 TYP.

3,81



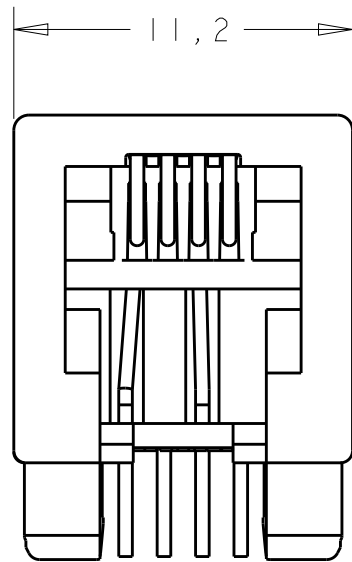
18,1

11,5

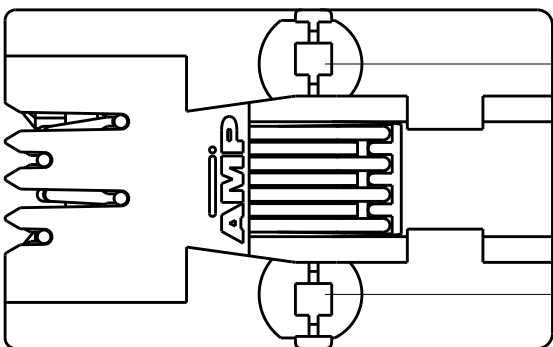
3,1

2,54

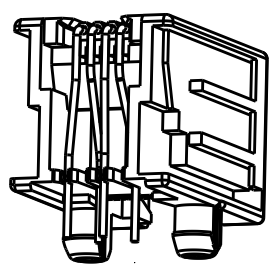
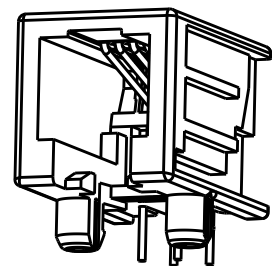
7,90



11,2

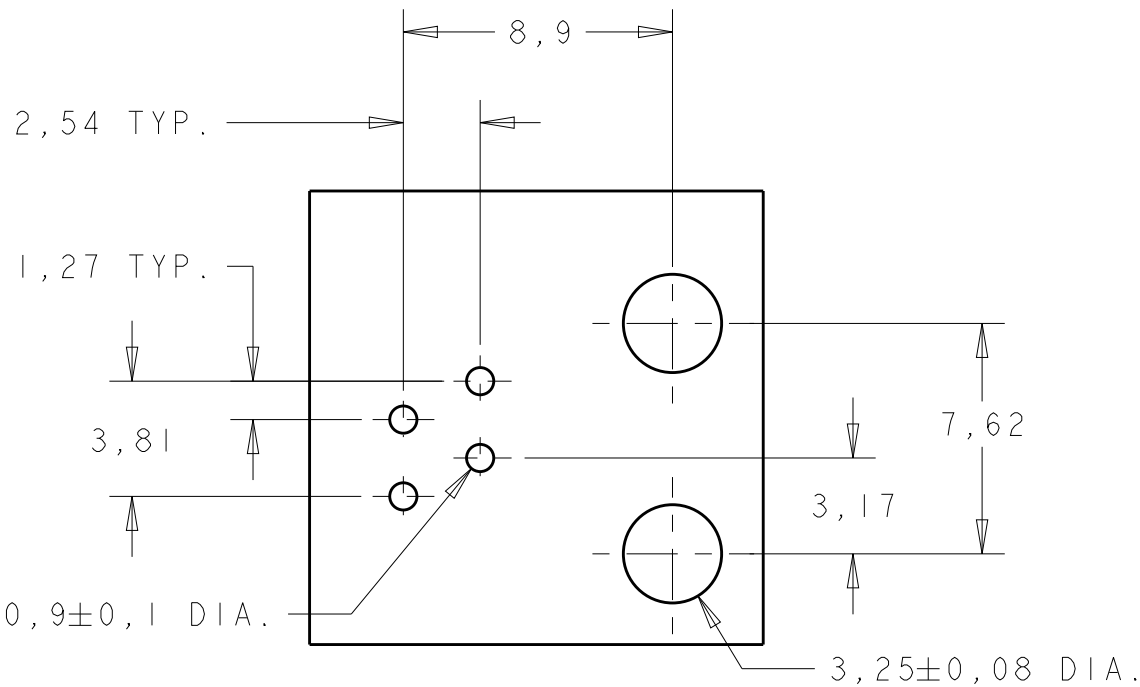


7,62



OBSOLETE

OVERALL: Ni 1.27µm MIN. ALL OVER THE CONTACTS SOLDER ZONE: Sn 2.5µm MIN. ON THE SOLDER ZONE OF THE CONTACT MATING ZONE: PLATING CONFIRMS TO PRODUCT REQUIREMENTS AS PER SPECIFICATION 108-19064	HOUSING, COLOR BLACK: PBT 20% GF, UL 94V-0 CONTACT INSERT: PBT, UL 94V-0 CONTACTS: PH, BRONZE	290 PCS IN A TRAY	1-215875-3
		50 PCS IN A TUBE (SEE SHEET 2)	3-215875-3
		BULK PACKAGED IN A BOX	2-215875-1
		TAPE MOUNTED 1000pcs./reel	215875-1
		PACKAGING	PARTNUMBER
FINISH	MATERIAL	PACKAGING	PARTNUMBER



PRINTED CIRCUIT BOARD LAYOUT

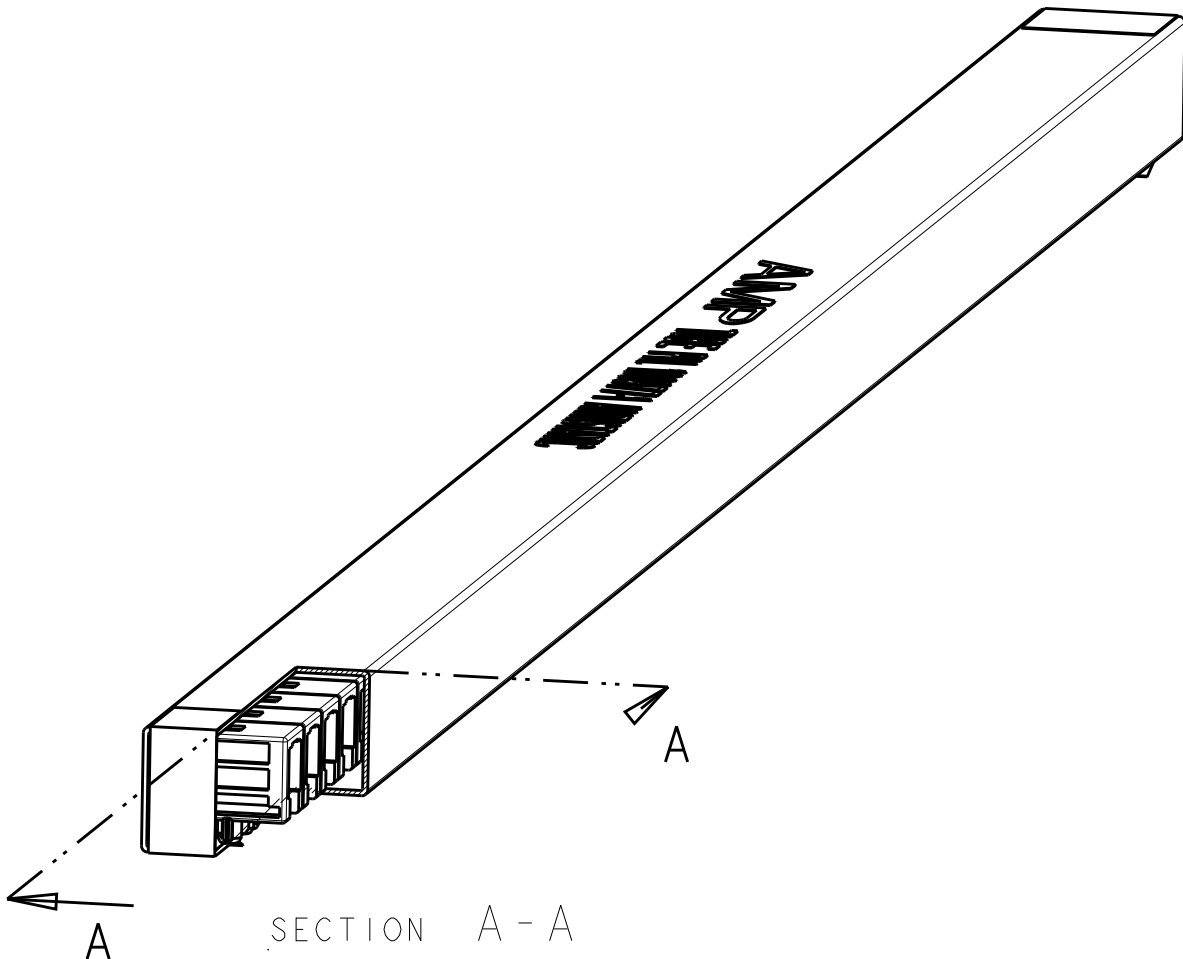
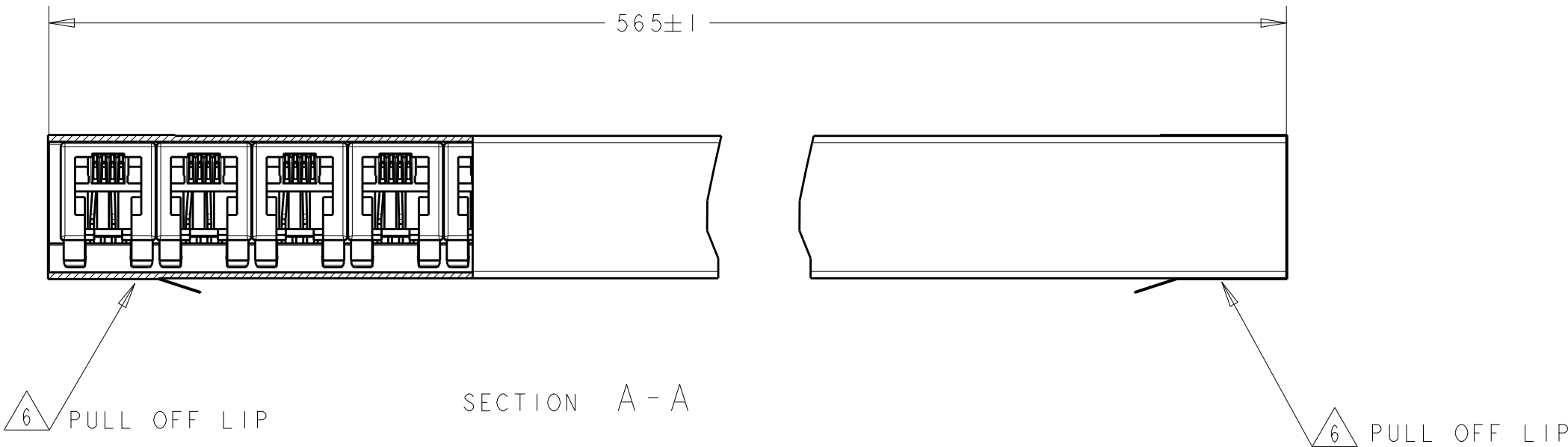
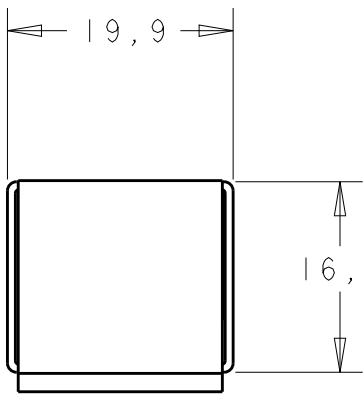
(VIEW SHOWN IS CIRCUIT (NON-COMPONENT) SIDE OF BOARD.)
PRINTED CIRCUIT BOARD THICKNESS: 1,6mm NOMINAL.
TOLERANCE UNLESS OTHERWISE SPECIFIED: ±0,05.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN E.v.EIJK	TE Connectivity			
		CHK M.v.ESSSEN				
DIMENSIONS: mm		APVD R.SMEETS	NAME MODULAR JACK SIDE ENTRY 4/4 FOR PRINTED CIRCUIT BOARD			
		PRODUCT SPEC 108-19064				
		APPLICATION SPEC 114-19019	SIZE A200779			
MATERIAL		WEIGHT				
		CUSTOMER DRAWING	RESTRICTED TO			
			SCALE 4:1			
			SHEET 1 OF 2			
			REV Y			

NOTES:

5 TUBE IS TRANSPARANT PVC.

6 TUBE IS CLOSED AT BOTH ENDS BY A TAPE.



1471-9 (3/11)